

TOSHIBA Field Effect Transistor with Built-in Schottky Barrier Diode
Silicon N-Channel MOS Type (Ultra-High-Speed U-MOS III)

TPC8A02-H

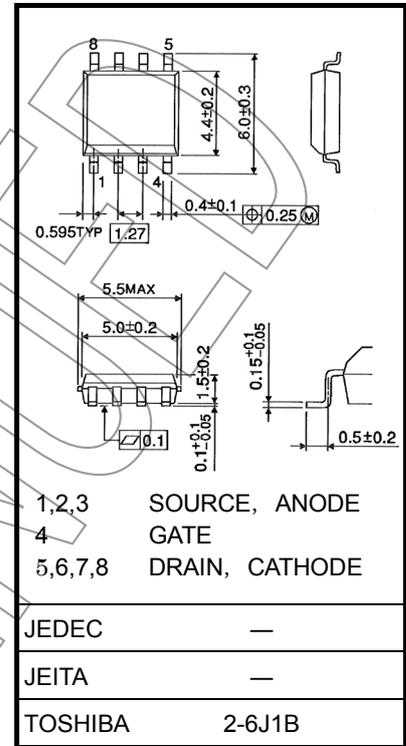
High-Efficiency DC/DC Converter Applications

Notebook PC Applications

Portable-Equipment Applications

- Built-in Schottky barrier diode
Low forward voltage: $V_{DSF} = 0.6V$ (max)
- High-speed switching.
- Small gate charge.: $Q_{SW} = 11$ nC (typ.)
- Low drain-source ON-resistance: $R_{DS(ON)} = 4.3$ m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 40$ S (typ.)
- Low leakage current: $I_{DSS} = 100$ μA (max) ($V_{DS} = 30$ V)
- Enhancement mode: $V_{th} = 1.1$ to 2.3 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

Unit: mm



Weight: 0.085 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

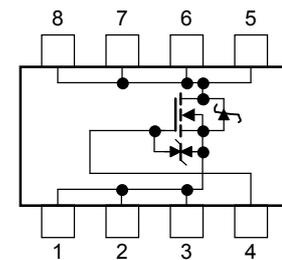
| Characteristic | | Symbol | Rating | Unit |
|---|----------------|-----------|------------|------|
| Drain-source voltage | | V_{DSS} | 30 | V |
| Drain-gate voltage ($R_{GS} = 20$ k Ω) | | V_{DGR} | 30 | V |
| Gate-source voltage | | V_{GSS} | ± 20 | V |
| Drain current | DC (Note 1) | I_D | 16 | A |
| | Pulse (Note 1) | I_{DP} | 48 | |
| Drain power dissipation (t = 10 s) (Note 2a) | | P_D | 1.9 | W |
| Drain power dissipation (t = 10 s) (Note 2b) | | P_D | 1.0 | W |
| Single-pulse avalanche energy (Note 3) | | E_{AS} | 166 | mJ |
| Avalanche current | | I_{AR} | 16 | A |
| Repetitive avalanche energy (Note 2a) (Note 4) | | E_{AR} | 0.11 | mJ |
| Channel temperature | | T_{ch} | 150 | °C |
| Storage temperature range | | T_{stg} | -55 to 150 | °C |

Note: For Notes 1 to 4, refer to the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care. Schottky barrier diodes have large-reverse-current-leakage characteristic compared to other rectifier products. This current leakage combined with improper operating temperature or voltage may cause thermal runaway. Please take forward and reverse loss into consideration during design.

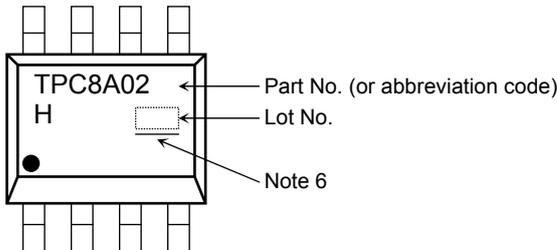
Circuit Configuration



Thermal Characteristics

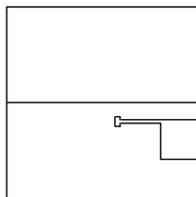
| Characteristic | Symbol | Max | Unit |
|---|----------------|------|------|
| Thermal resistance, channel to ambient (t = 10 s) (Note 2a) | $R_{th(ch-a)}$ | 65.8 | °C/W |
| Thermal resistance, channel to ambient (t = 10 s) (Note 2b) | $R_{th(ch-a)}$ | 125 | °C/W |

Marking (Note 5)



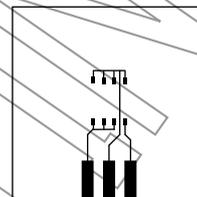
Note 1: The channel temperature should not exceed 150°C during use.

Note 2: (a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



(a)

FR-4
25.4 × 25.4 × 0.8
(Unit: mm)



(b)

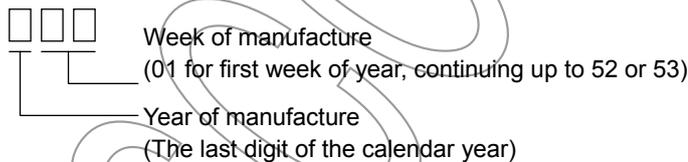
FR-4
25.4 × 25.4 × 0.8
(Unit: mm)

Note 3: $V_{DD} = 24\text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 1.0\text{ mH}$, $R_G = 25\ \Omega$, $I_{AR} = 7\text{ A}$

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: • on the lower left of the marking indicates Pin 1.

* Weekly code: (Three digits)



Note 6: A line under a Lot No. identifies the indication of product Labels.

Not underlined: $[[Pb]]/INCLUDES > MCV$

Underlined: $[[G]]/RoHS\ COMPATIBLE$ or $[[G]]/RoHS\ [[Pb]]$

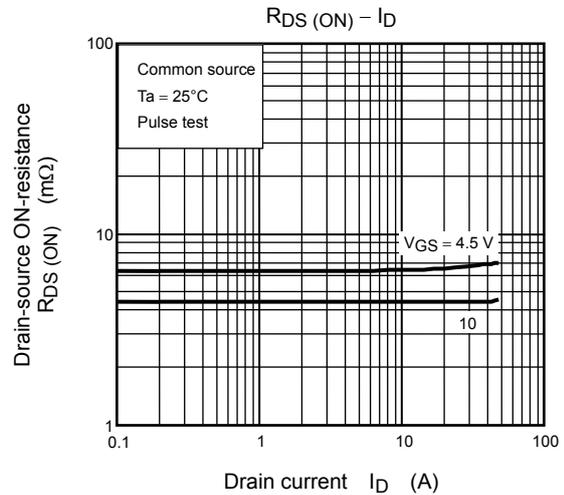
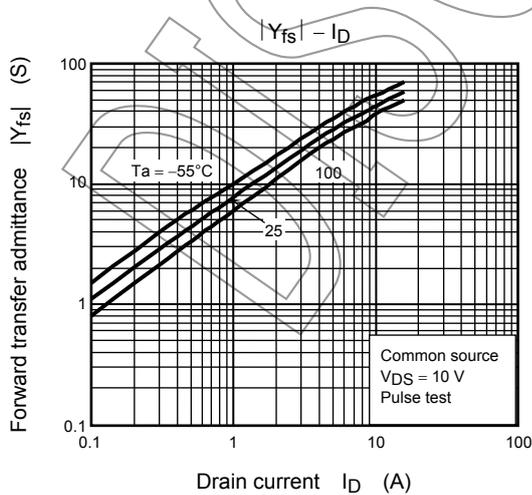
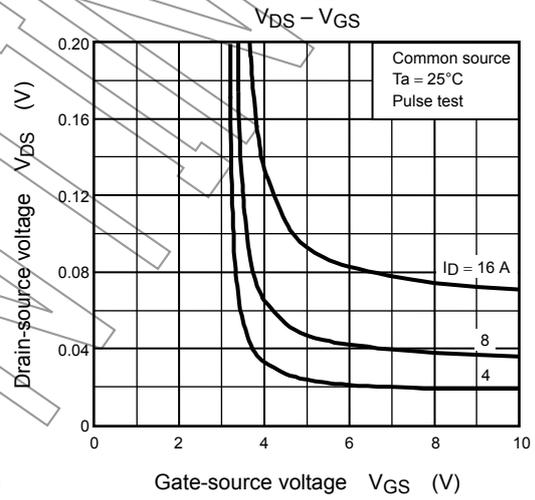
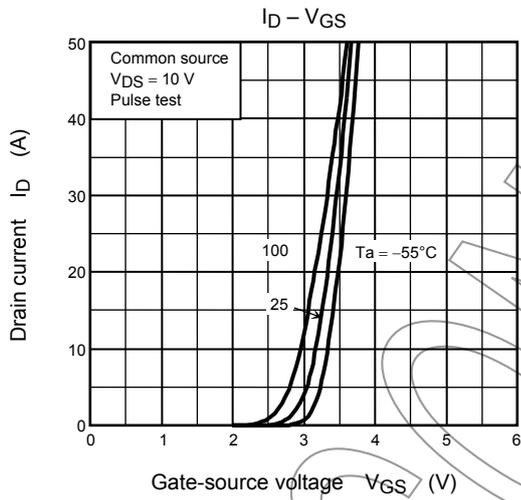
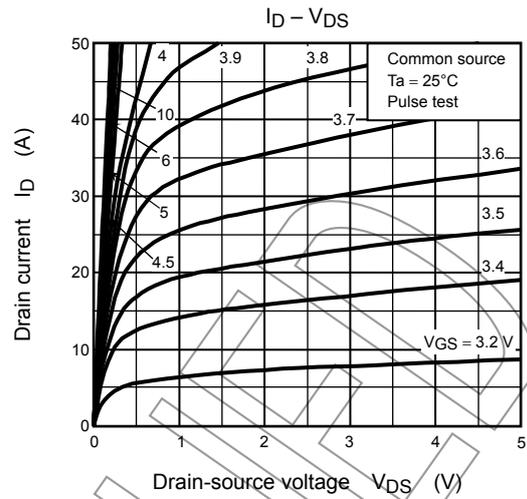
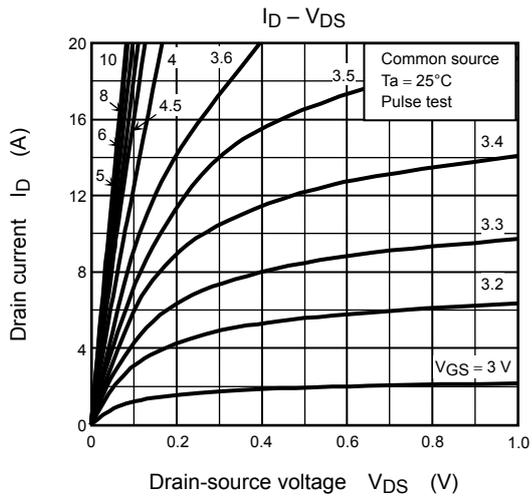
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

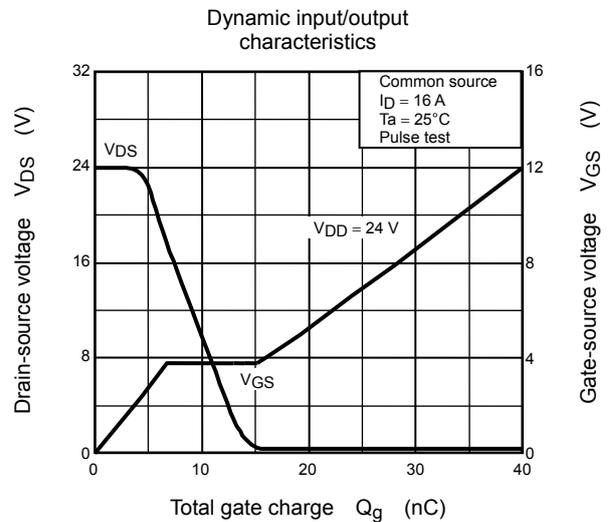
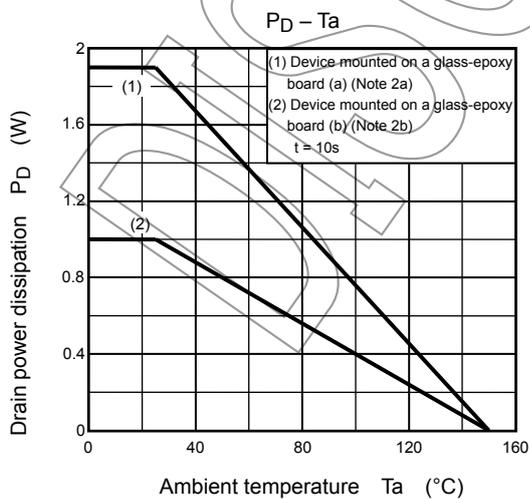
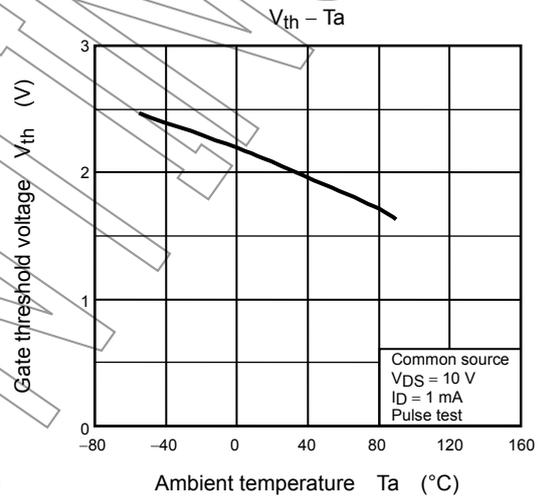
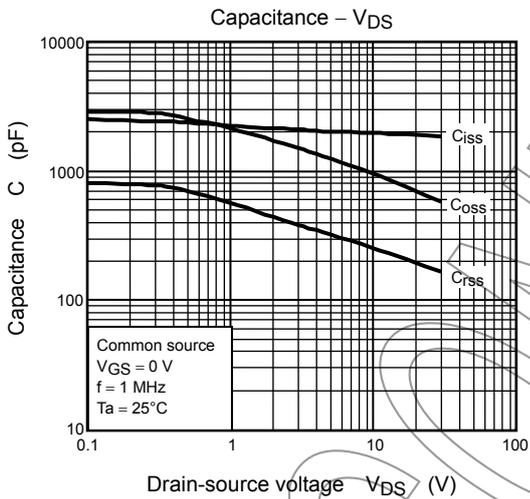
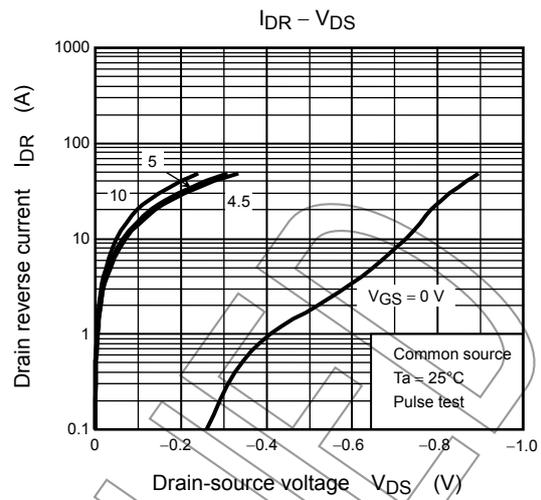
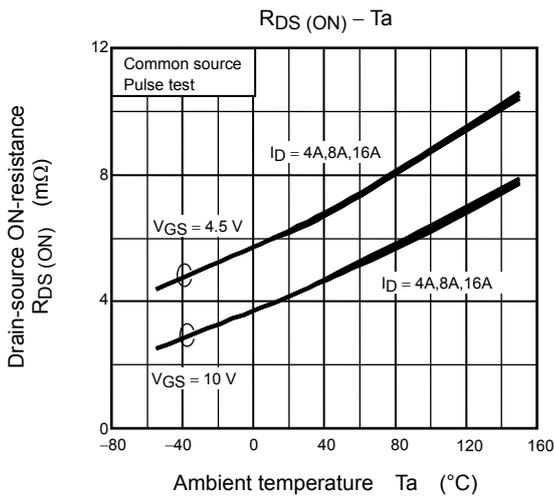
Electrical Characteristics (Ta = 25°C)

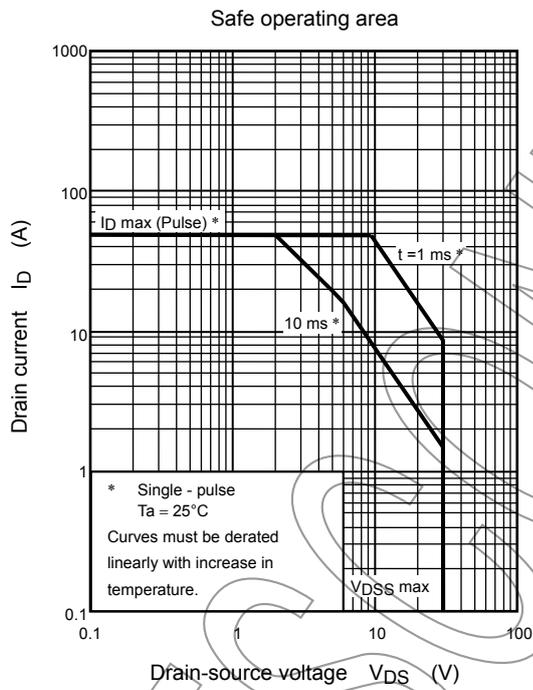
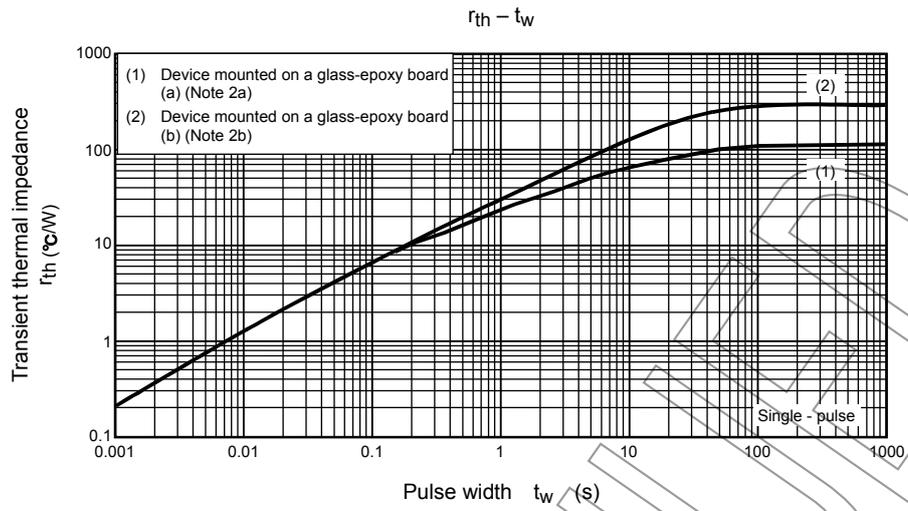
| Characteristic | | Symbol | Test Condition | Min | Typ. | Max | Unit |
|---|---------------|---------------|---|---|------|----------|------------------|
| Gate leakage current | | I_{GSS} | $V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$ | — | — | ± 10 | μA |
| Drain cutoff current | | I_{DSS} | $V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$ | — | — | 100 | μA |
| Drain-source breakdown voltage | | $V_{(BR)DSS}$ | $I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$ | 30 | — | — | V |
| | | $V_{(BR)DSX}$ | $I_D = 10\text{ mA}, V_{GS} = -20\text{ V}$ | 15 | — | — | |
| Gate threshold voltage | | V_{th} | $V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$ | 1.1 | — | 2.3 | V |
| Drain-source ON-resistance | | $R_{DS(ON)}$ | $V_{GS} = 4.5\text{ V}, I_D = 8\text{ A}$ | — | 6.2 | 8.5 | $\text{m}\Omega$ |
| | | | $V_{GS} = 10\text{ V}, I_D = 8\text{ A}$ | — | 4.3 | 5.6 | |
| Forward transfer admittance | | $ Y_{fs} $ | $V_{DS} = 10\text{ V}, I_D = 8\text{ A}$ | 20 | 40 | — | S |
| Input capacitance | | C_{iss} | $V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$ | — | 1970 | — | pF |
| Reverse transfer capacitance | | C_{rss} | | — | 240 | — | |
| Output capacitance | | C_{oss} | | — | 950 | — | |
| Switching time | Rise time | t_r | | — | 6 | — | ns |
| | Turn-on time | t_{on} | | — | 14 | — | |
| | Fall time | t_f | | — | 12 | — | |
| | Turn-off time | t_{off} | | Duty $\leq 1\%$, $t_w = 10\ \mu\text{s}$ | — | 26 | |
| Total gate charge (gate-source plus gate-drain) | | Q_g | $V_{DD} \approx 24\text{ V}, V_{GS} = 10\text{ V}, I_D = 16\text{ A}$ | — | 34 | — | nC |
| | | | $V_{DD} \approx 24\text{ V}, V_{GS} = 5\text{ V}, I_D = 16\text{ A}$ | — | 19 | — | |
| Gate-source charge 1 | | Q_{gs1} | | — | 6 | — | |
| Gate-drain ("Miller") charge | | Q_{gd} | $V_{DD} \approx 24\text{ V}, V_{GS} = 10\text{ V}, I_D = 16\text{ A}$ | — | 8.4 | — | |
| Gate switch charge | | Q_{sw} | | — | 11 | — | |

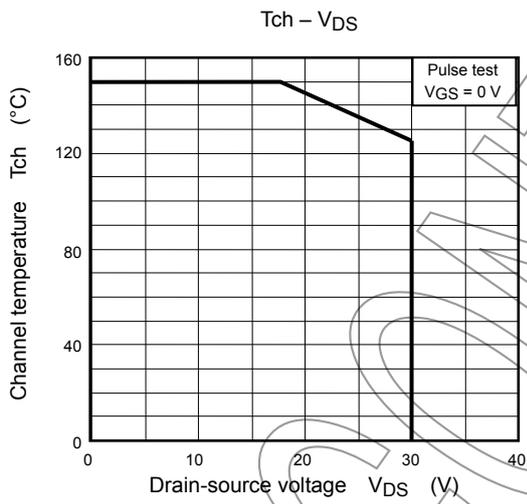
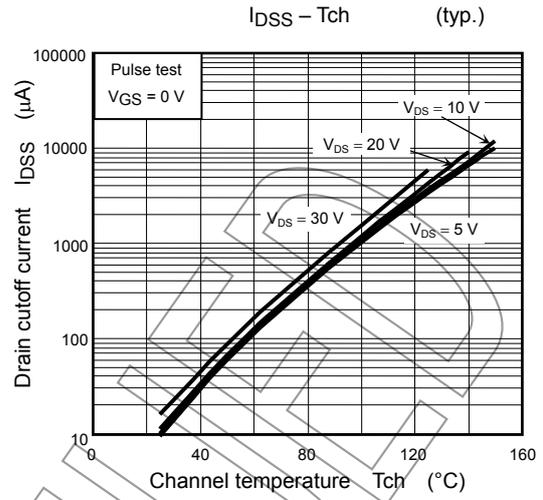
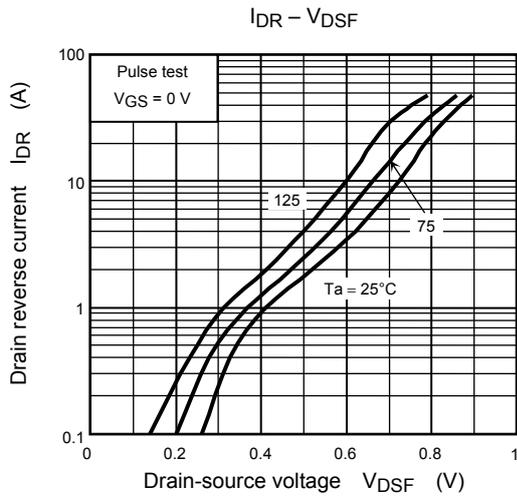
Source-Drain Ratings and Characteristics (Ta = 25°C)

| Characteristic | | Symbol | Test Condition | Min | Typ. | Max | Unit |
|----------------------|---|-----------|--|-----|-------|------|------|
| Peak forward current | Pulse (Note 1) | I_{FP} | — | — | — | 48 | A |
| | Forward voltage (diode) | V_{DSF} | $I_{DR} = 1.0\text{ A}, V_{GS} = 0\text{ V}$ | — | -0.45 | -0.6 | V |
| | $I_{DR} = 16\text{ A}, V_{GS} = 0\text{ V}$ | | — | — | -1.2 | | |









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